

100 6-8-99

ASSIGNMENT RECORDATION COVER SHEET
-PATENTS ONLY-

10525 U.S. PTO
09/330432
06/08/99

To: Honorable Commissioner of Patents and Trademarks:

Please record the attached original document or copy thereof.

1. Name of conveying party:
a) Kuan-Yang Liao

06-24-1999



2. Names and addresses of receiving parties:

101073922

1) Name: United Silicon Incorporated

Address: No. 3, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu,
Taiwan, R.O.C.

2) Name: United Microelectronics Corp.

Address: No. 3, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu,
Taiwan, R.O.C.

09/330,432

3. Nature of conveyance

☒ Assignment
☐ Security Agreement
☐ Other _____

☐ Merger
☐ Change of Name
☐ License Agreement

Execution Date: May 19, 1999

4. Application Number or Patent Number: Not yet assigned

The title of the new application is: METHOD OF DEFINING A CONDUCTIVE LAYER

5. Please send all correspondence concerning this document to:

Peter B. Martine
MARTINE PENILLA & KIM, LLP
830 West Evelyn Avenue
Sunnyvale, California 94086
Tel. No. (408) 749-6900
Fax No. (408) 749-6901

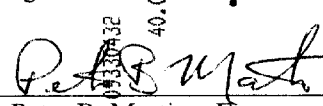
6. Total number of applications and patents involved: 1

7. Total fee (37 CFR § 3.41): \$40.00

☒ Enclosed
☒ Any deficiency may be charged to Deposit Account No. 50-0805
(Order No. JCTWP032).

8. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Date: June 8, 1999


Peter B. Martine, Esq.
Registration No. 32,043

Attorney Docket No. JCTWP032

(Revised 01/96)

PATENT
REEL: 010037 FRAME: 0005

ASSIGNMENT

WHEREAS,

1. Kuan-Yang Liao

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **METHOD OF DEFINING A CONDUCTIVE LAYER**

[] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, (1) United Silicon Incorporated, of
No. 3, Li-Hsin II Rd., Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.
(2) United Microelectronics Corp., of
No. 3, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.


hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

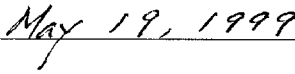
Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.



Signature:



Date:

Sole or First Joint Inventor: Kuan-Yang Liao